



### Dual N-Channel 30-V (D-S) MOSFET with Schottky Diode

#### CHARACTERISTICS

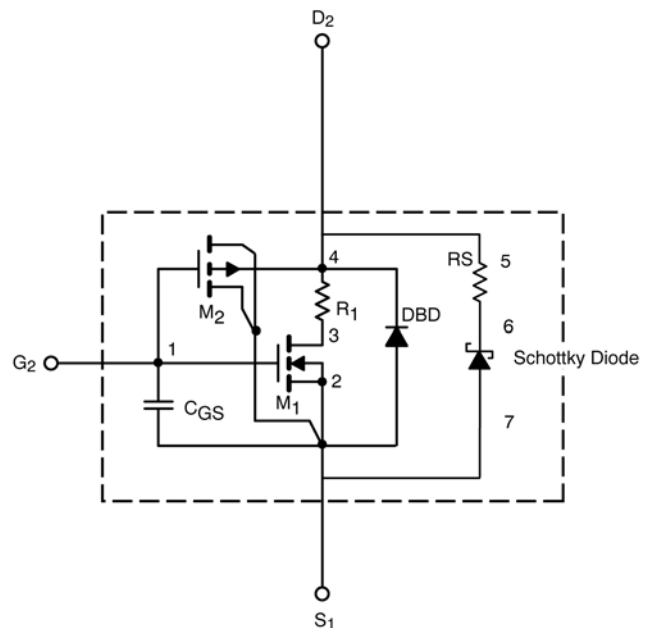
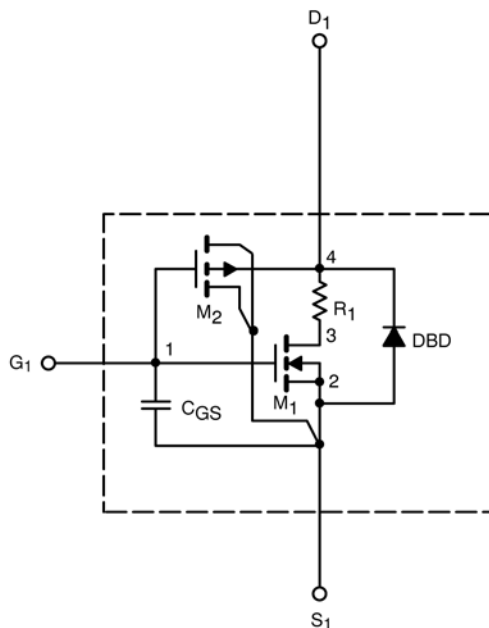
- N-Channel Vertical DMOS
- Macro Model (Subcircuit Model)
- Level 3 MOS
- Apply for both Linear and Switching Application
- Accurate over the  $-55$  to  $125^{\circ}\text{C}$  Temperature Range
- Model the Gate Charge, Transient, and Diode Reverse Recovery Characteristics

#### DESCRIPTION

The attached spice model describes the typical electrical characteristics of the n-channel vertical DMOS. The subcircuit model is extracted and optimized over the  $-55$  to  $125^{\circ}\text{C}$  temperature ranges under the pulsed 0-V to 10-V gate drive. The saturated output impedance is best fit at the gate bias near the threshold voltage.

A novel gate-to-drain feedback capacitance network is used to model the gate charge characteristics while avoiding convergence difficulties of the switched  $C_{gd}$  model. All model parameter values are optimized to provide a best fit to the measured electrical data and are not intended as an exact physical interpretation of the device.

#### SUBCIRCUIT MODEL SCHEMATIC



This document is intended as a SPICE modeling guideline and does not constitute a commercial product data sheet. Designers should refer to the appropriate data sheet of the same number for guaranteed specification limits.

SPECIFICATIONS (T <sub>J</sub> = 25°C UNLESS OTHERWISE NOTED)							
Parameter	Symbol	Test Condition		Simulated Data	Measured Data	Unit	
<b>Static</b>							
Gate Threshold Voltage	V <sub>GS(th)</sub>	V <sub>DS</sub> = V <sub>GS</sub> , I <sub>D</sub> = 250 μA	Ch-1	1.8		V	
			Ch-2	1.4			
On-State Drain Current <sup>a</sup>	I <sub>D(on)</sub>	V <sub>DS</sub> = 5 V, V <sub>GS</sub> = 10 V	Ch-1	261		A	
			Ch-2	279			
Drain-Source On-State Resistance <sup>a</sup>	r <sub>DS(on)</sub>	V <sub>GS</sub> = 10 V, I <sub>D</sub> = 7.5 A	Ch-1	0.018	0.017	Ω	
		V <sub>GS</sub> = 10 V, I <sub>D</sub> = 7.5 A	Ch-2	0.016	0.016		
		V <sub>GS</sub> = 4.5 V, I <sub>D</sub> = 6.5 A	Ch-1	0.025	0.024		
		V <sub>GS</sub> = 4.5 V, I <sub>D</sub> = 6.5 A	Ch-2	0.020	0.020		
Forward Transconductance <sup>a</sup>	g <sub>fs</sub>	V <sub>DS</sub> = 15 V, I <sub>D</sub> = 7.5 A	Ch-1	19	19	S	
		V <sub>DS</sub> = 15 V, I <sub>D</sub> = 7.5 A	Ch-2	21	21		
Diode Forward Voltage <sup>b</sup>	V <sub>SD</sub>	I <sub>S</sub> = 1 A, V <sub>GS</sub> = 0 V	Ch-1	0.73	0.75	V	
		I <sub>S</sub> = 1 A, V <sub>GS</sub> = 0 V	Ch-2	0.43	0.47		
<b>Dynamic<sup>b</sup></b>							
Total Gate Charge	Q <sub>g</sub>	Channel-1 V <sub>DS</sub> = 15 V, V <sub>GS</sub> = 4.5 V, I <sub>D</sub> = 7.5 A Channel-2 V <sub>DS</sub> = 15 V, V <sub>GS</sub> = 4.5 V, I <sub>D</sub> = 7.5 A	Ch-1	7.2	7	nC	
			Ch-2	11.5	11.5		
Gate-Source Charge	Q <sub>gs</sub>		Ch-1	2.9	2.9		
			Ch-2	3.8	3.8		
Gate-Drain Charge	Q <sub>gd</sub>		Ch-1	2.5	2.5		
			Ch-2	3.5	3.5		
Turn-On Delay Time	t <sub>d(on)</sub>		Channel-1 V <sub>DD</sub> = 15 V, R <sub>L</sub> = 15 Ω I <sub>D</sub> ≅ 1 A, V <sub>GEN</sub> = 10 V, R <sub>G</sub> = 6 Ω Channel-2 V <sub>DD</sub> = 15 V, R <sub>L</sub> = 15 Ω I <sub>D</sub> ≅ 1 A, V <sub>GEN</sub> = 10 V, R <sub>G</sub> = 6 Ω	Ch-1	13	9	ns
				Ch-2	13	12	
Turn-Off Delay Time	t <sub>d(off)</sub>			Ch-1	8	10	
				Ch-2	8	10	
		Ch-1		11	19		
		Ch-2		22	40		
Fall Time	t <sub>f</sub>	Ch-1		10	9		
		Ch-2		15	9		
Source-Drain Reverse Recovery Time	t <sub>rr</sub>	I <sub>F</sub> = 1.7 A, di/dt = 100 A/μs	Ch-1	27	35		
		I <sub>F</sub> = 1.7 A, di/dt = 100 A/μs	Ch-2	20	28		

### Notes

- a. Pulse test; pulse width ≤ 300 μs, duty cycle ≤ 2%.  
 b. Guaranteed by design, not subject to production testing.

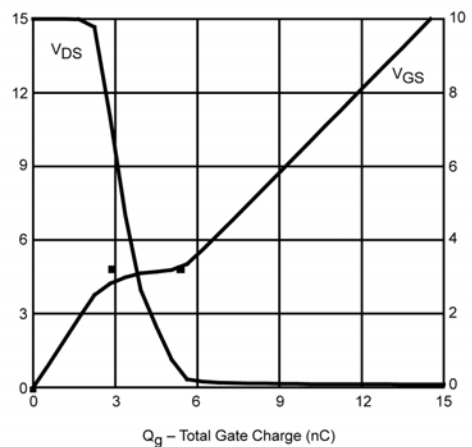
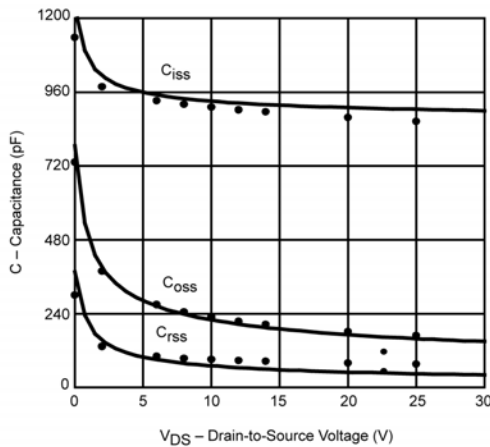
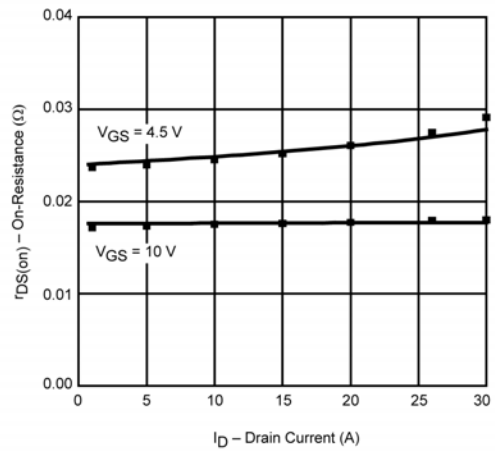
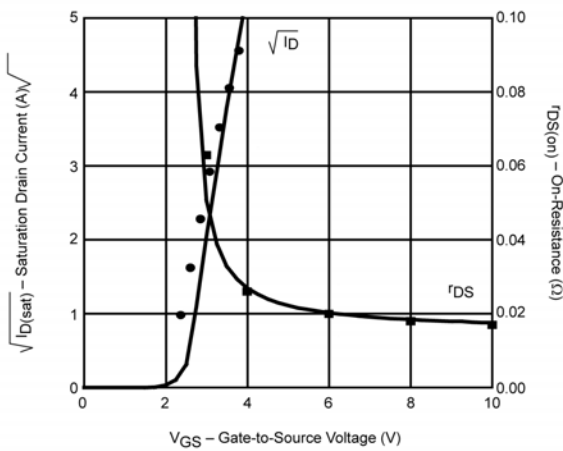
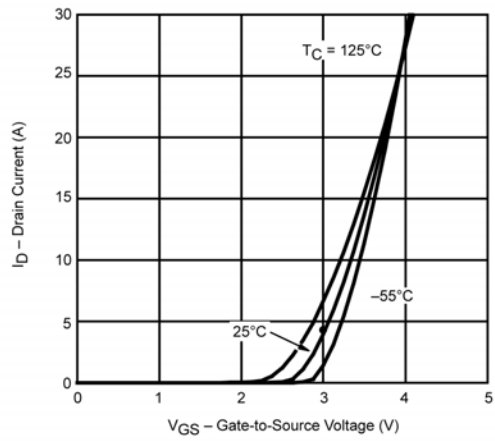
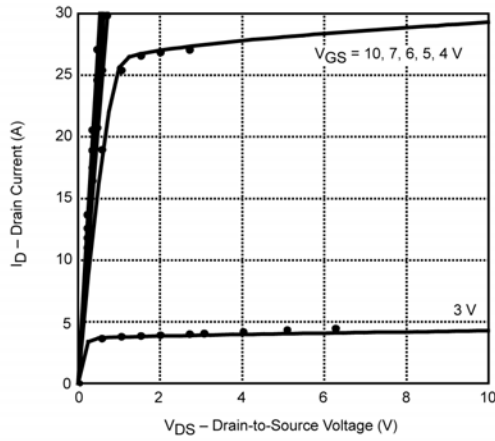


# SPICE Device Model Si7872DP

## Vishay Siliconix

COMPARISON OF MODEL WITH MEASURED DATA ( $T_J=25^\circ\text{C}$  UNLESS OTHERWISE NOTED)

### Channel 1



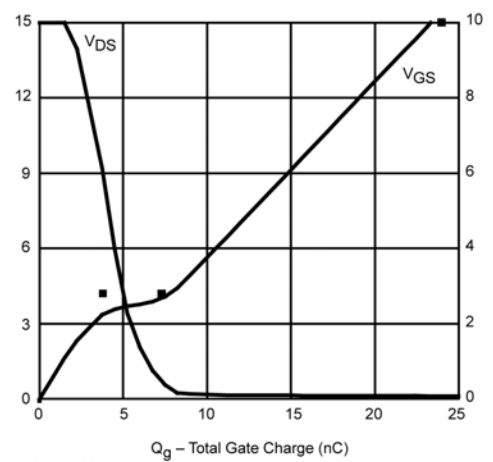
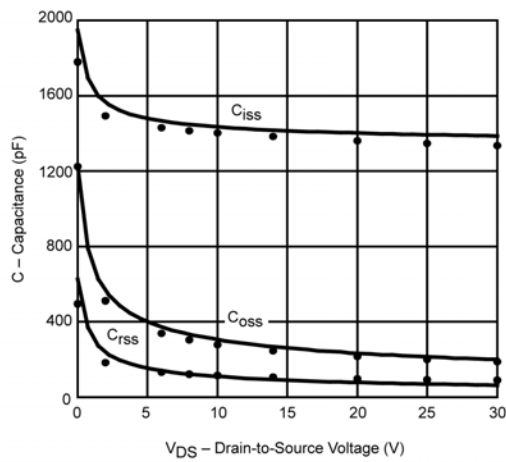
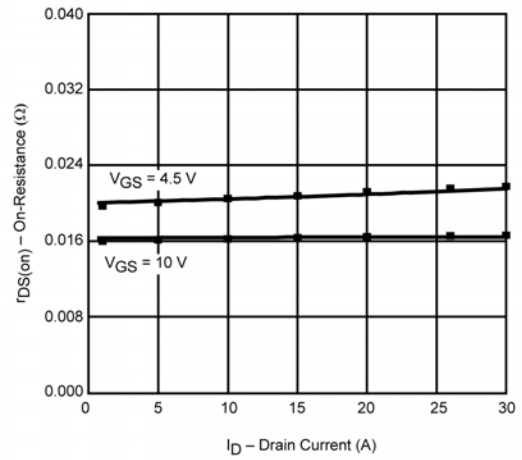
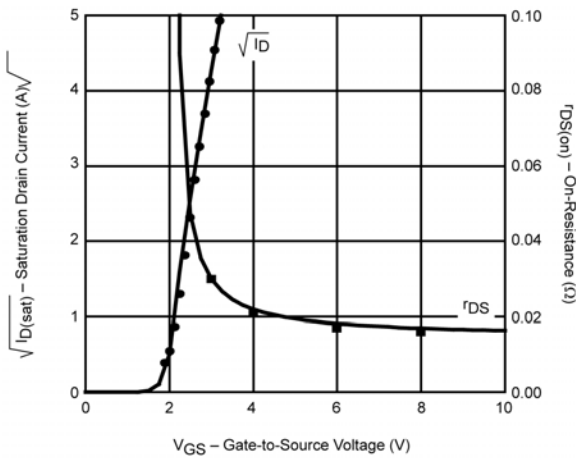
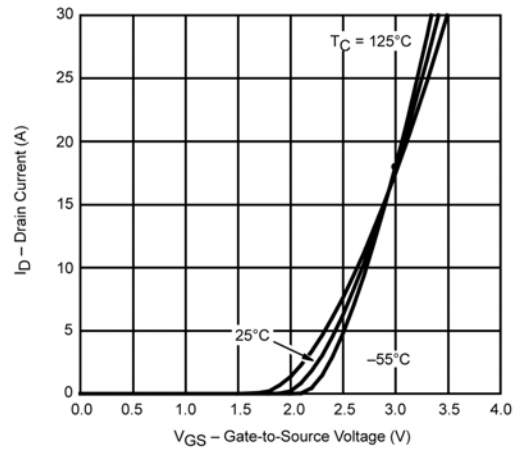
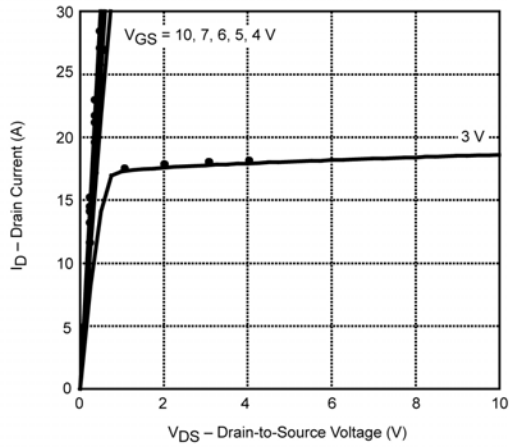
Note: Dots and squares represent measured data.

# SPICE Device Model Si7872DP

## Vishay Siliconix



### Channel 2



Note: Dots and squares represent measured data.



## Disclaimer

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